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| <b>Notice of References Cited</b> |  | Application/Control No.<br>10/637,094 | Applicant(s)/Patent Under<br>Reexamination<br>GHYSELEN ET AL. |             |
|                                   |  | Examiner<br>Thanh V Pham              | Art Unit<br>2823  | Page 1 of 1 |

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|   | B | US-6,751,343                                     | 06-2004         | Ferrell et al. | 382/145        |
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\*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)

Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.